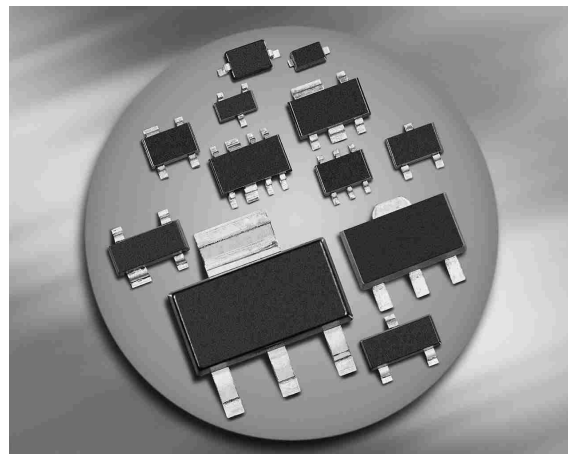
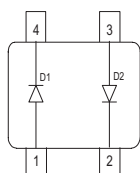


Silicon Schottky Diode

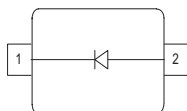
- Low barrier diode for detectors up to GHz frequencies
- Pb-free (RoHS compliant) package



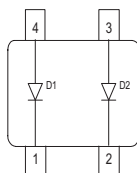
BAT62



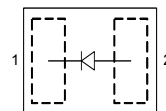
BAT62-03W BAT62-02V BAT62-02W



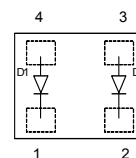
BAT62-07W



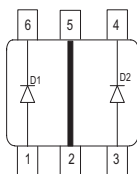
BAT62-02L BAT62-02LS



BAT62-07L4



BAT62-09S



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Type	Package	Configuration	L_S (nH)	Marking
BAT62-02W**	SCD80	single	0.6	62
BAT62	SOT143	anti-parallel pair	2	62s
BAT62-02L	TSLP-2-1	single, leadless	0.4	L
BAT62-02LS*	TSSLP-2-1	single, leadless	0.2	U
BAT62-02V	SC79	single	0.6	k
BAT62-03W	SOD323	single	1.8	white L
BAT62-07L4	TSLP-4-4	parallel pair, leadless	0.4	62
BAT62-07W	SOT343	parallel pair	1.8	62s
BAT62-09S	SOT363	parallel high, high isolation	1.6	69s

* Preliminary Data

** Not for new design

Maximum Ratings at $T_A = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Value	Unit
Diode reverse voltage	V_R	40	V
Forward current	I_F	20	mA
Total power dissipation BAT62, $T_S \leq 85\text{ °C}$ BAT62-02L, -07L4, -03W, $T_S \leq 108\text{ °C}$ BAT62-02W, -02V, $T_S \leq 109\text{ °C}$ BAT62-07W, $T_S \leq 103\text{ °C}$ BAT62-09S, $T_S \leq 105\text{ °C}$	P_{tot}	100 100 100 100 100	
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾ BAT62 BAT62-02L, -07L4, -03W BAT62-02W, 02V BAT62-07W BAT62-09S	R_{thJS}	≤ 650 ≤ 420 ≤ 410 ≤ 470 $\leq \text{td}$	

Electrical Characteristics at $T_A = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse current $V_R = 40\text{ V}$	I_R	-	-	10	μA
Forward voltage $I_F = 2\text{ mA}$	V_F	-	0.58	1	V
Forward voltage matching ²⁾ $I_F = 2\text{ mA}$	ΔV_F	-	-	20	mV

¹⁾For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

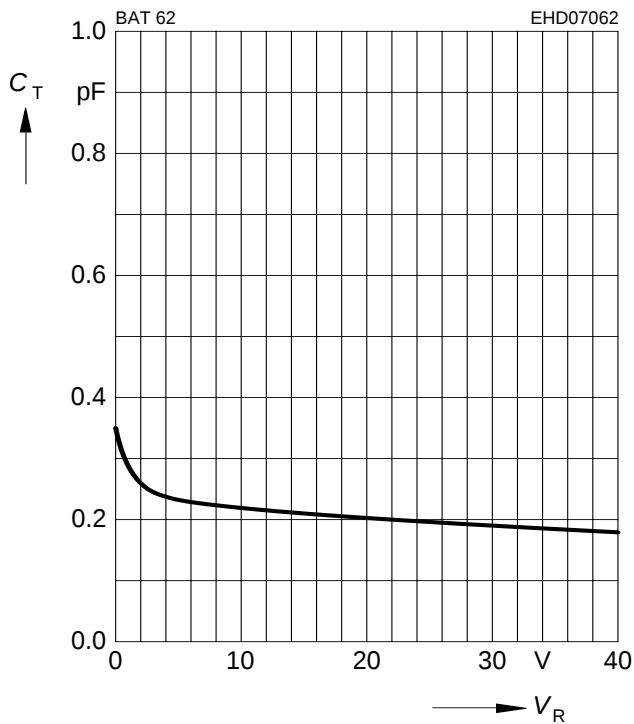
²⁾ ΔV_F is the difference between lowest and highest V_F in a multiple diode component.

Electrical Characteristics at $T_A = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC Characteristics					
Diode capacitance $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_T	-	0.35	0.6	pF
Differential resistance $V_R = 0\text{ V}$, $f = 10\text{ kHz}$	R_0	-	225	-	kΩ

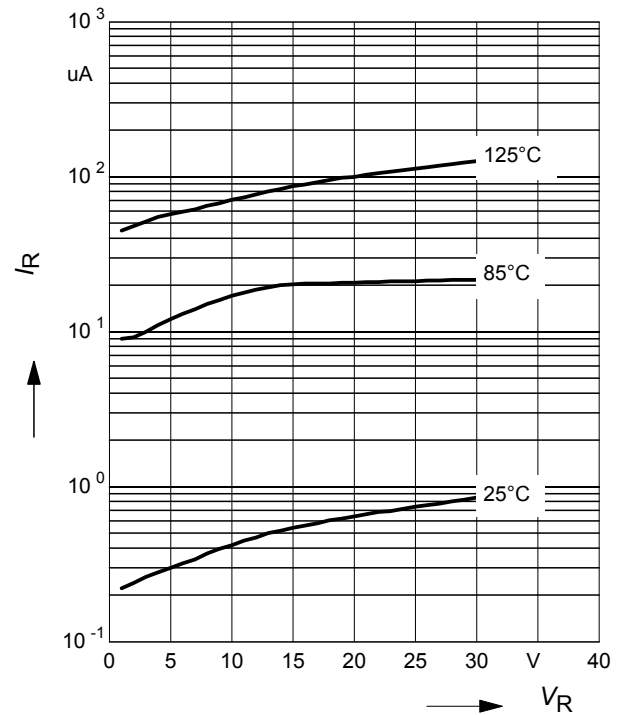
Diode capacitance $C_T = f(V_R)$

$f = 1\text{MHz}$



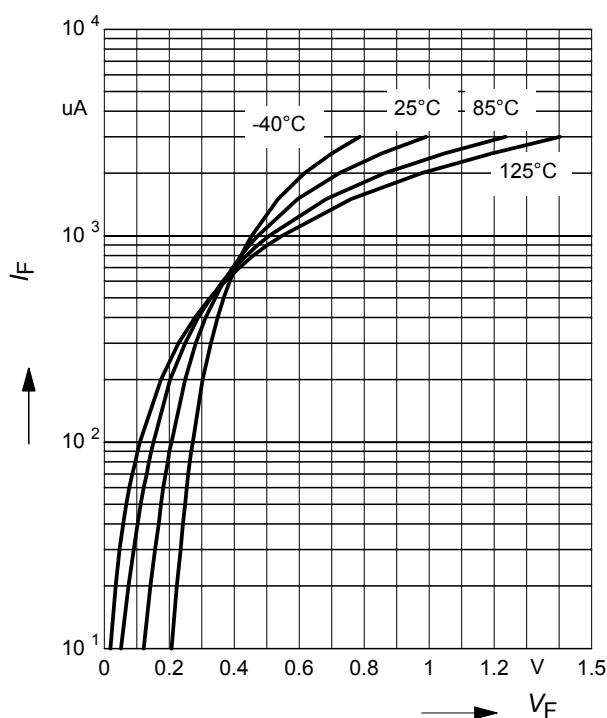
Reverse current $I_R = f(V_R)$

$T_A = \text{Parameter}$



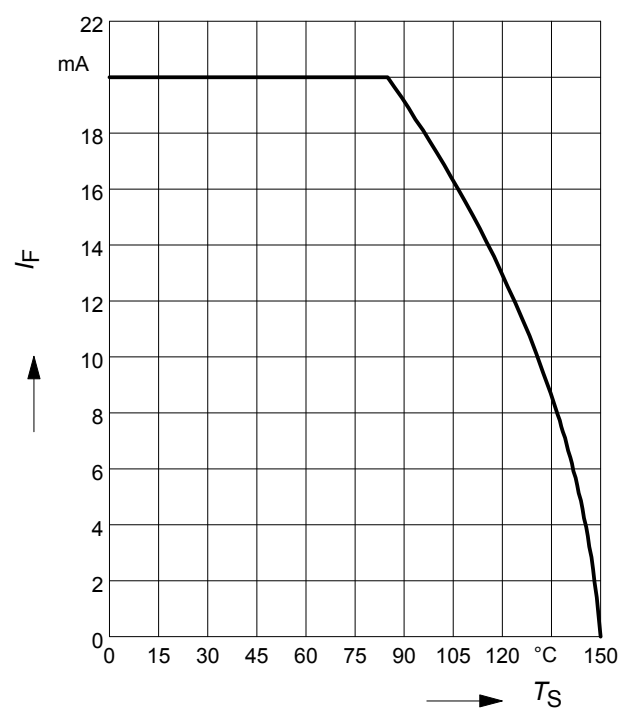
Forward current $I_F = f(V_F)$

$T_A = \text{Parameter}$



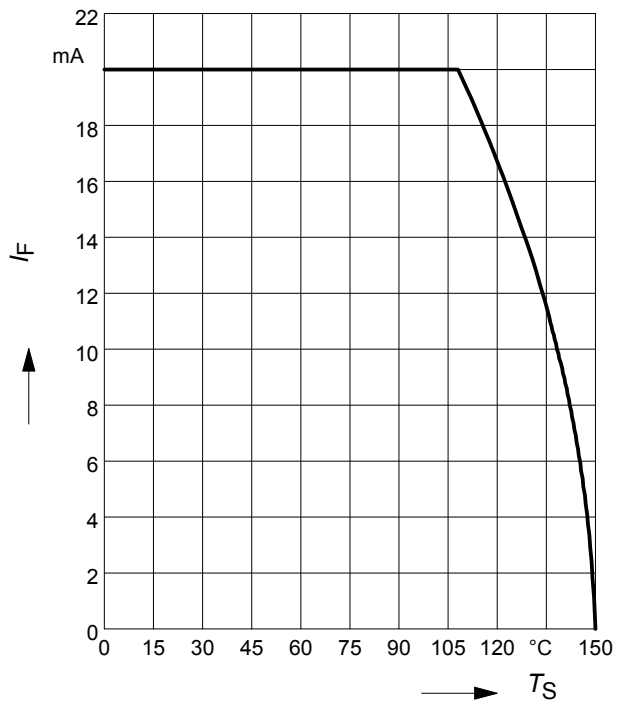
Forward current $I_F = f(T_S)$

BAT62



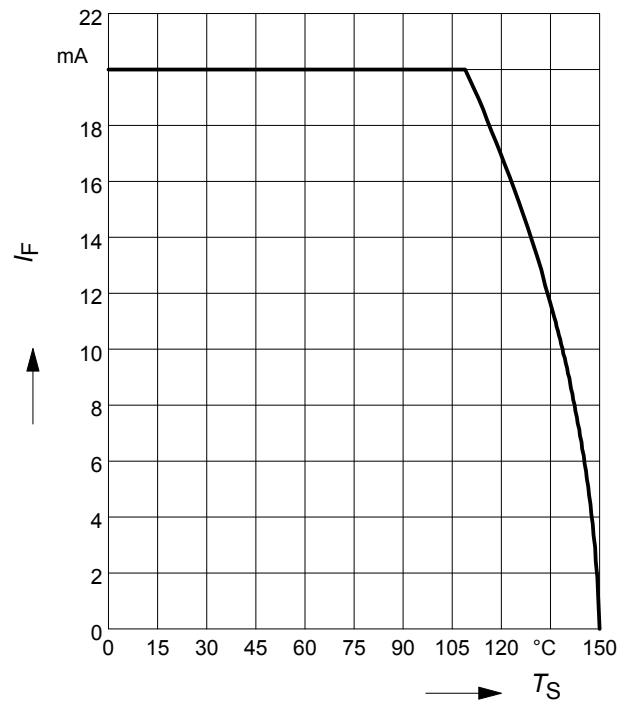
Forward current $I_F = f(T_S)$

BAT62-02L, -07L4



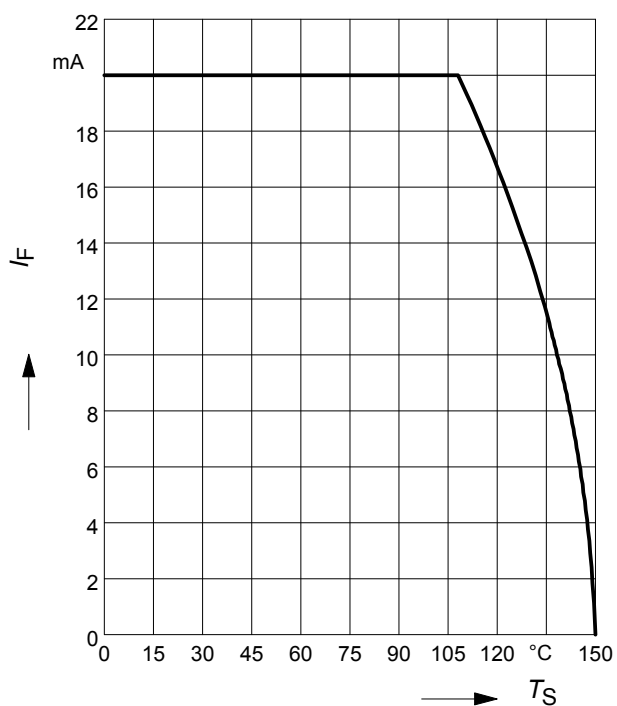
Forward current $I_F = f(T_S)$

BAT62-02W, -02V



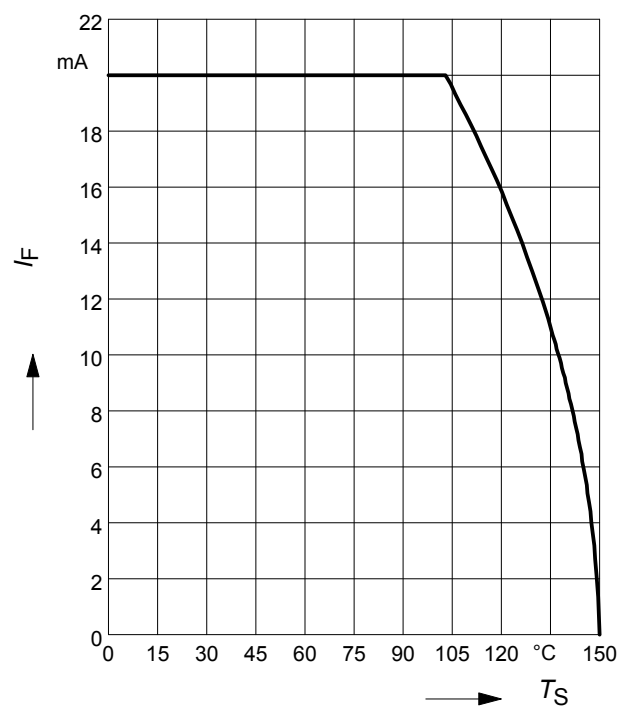
Forward current $I_F = f(T_S)$

BAT62-03W



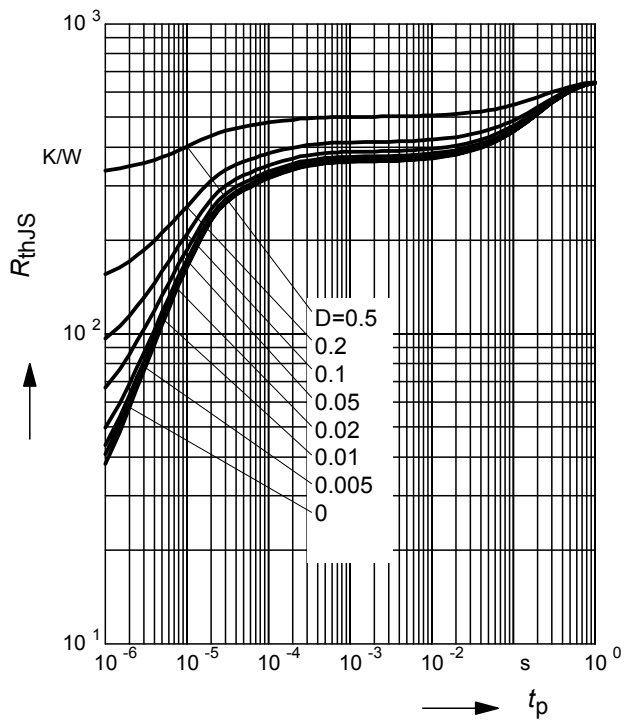
Forward current $I_F = f(T_S)$

BAT62-07W



Permissible Puls Load $R_{thJS} = f(t_p)$

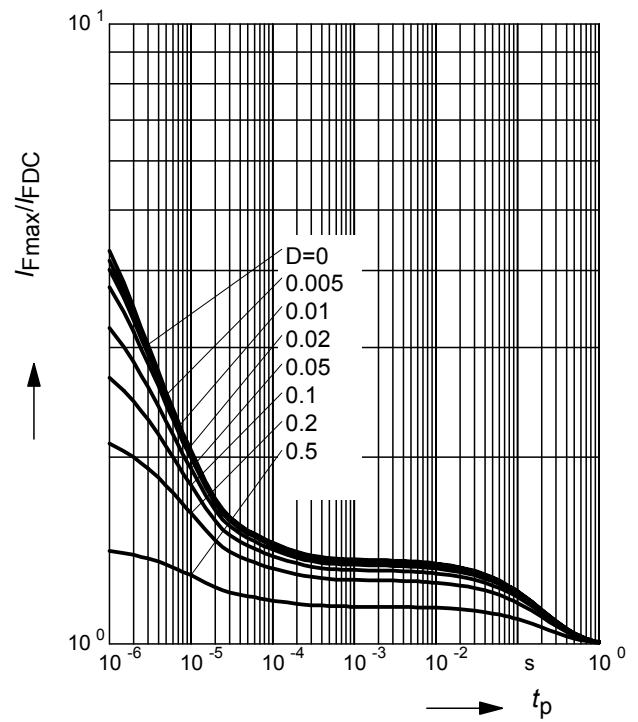
BAT62



Permissible Pulse Load

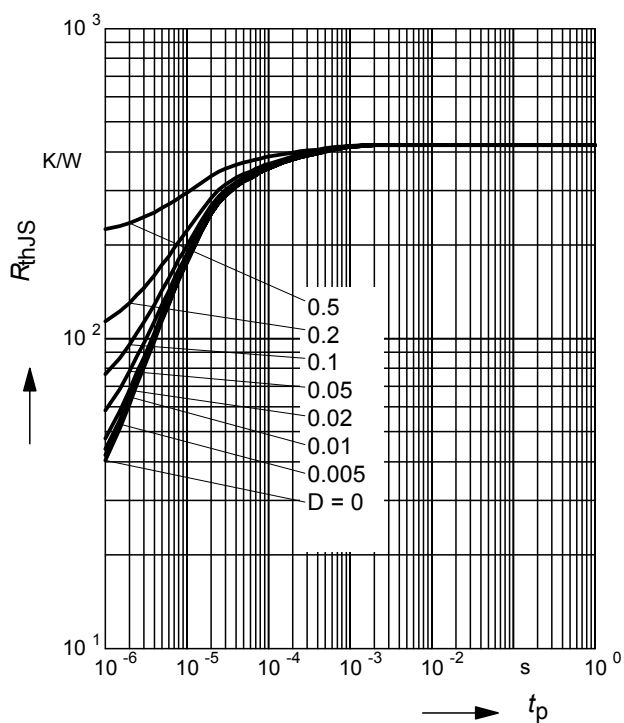
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62



Permissible Puls Load $R_{thJS} = f(t_p)$

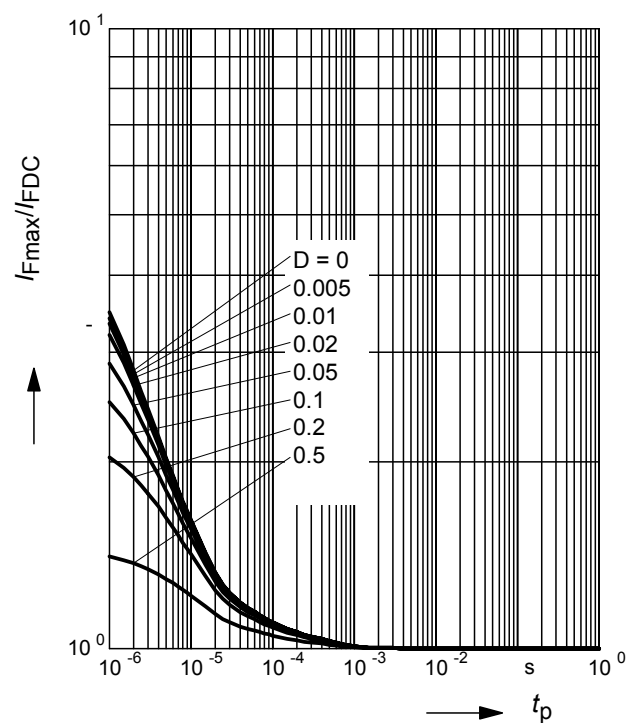
BAT62-02L, -07L4



Permissible Pulse Load

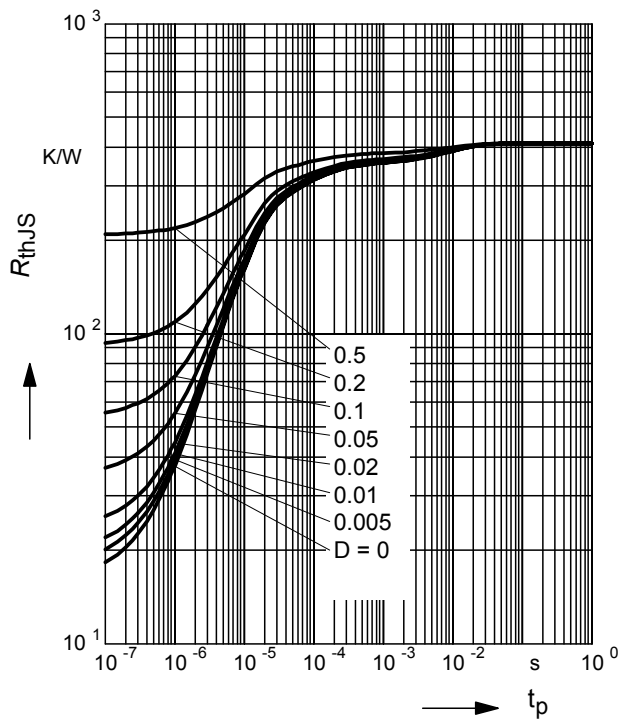
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62-02L, -07L4



Permissible Puls Load $R_{thJS} = f(t_p)$

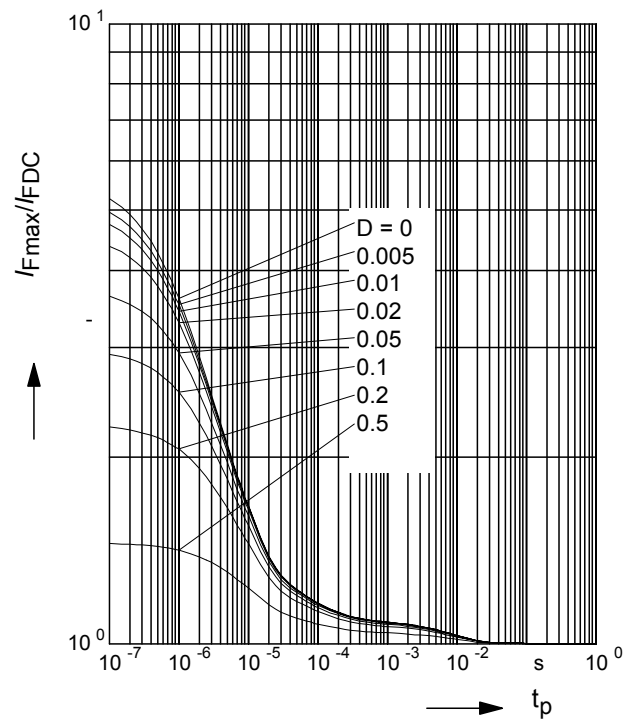
BAT62-02W, 02V



Permissible Pulse Load

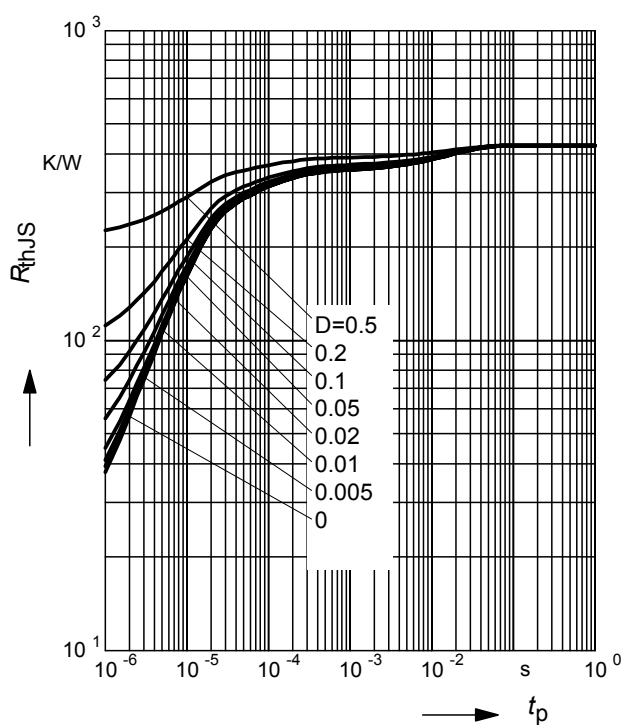
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62-02W, -02V



Permissible Puls Load $R_{thJS} = f(t_p)$

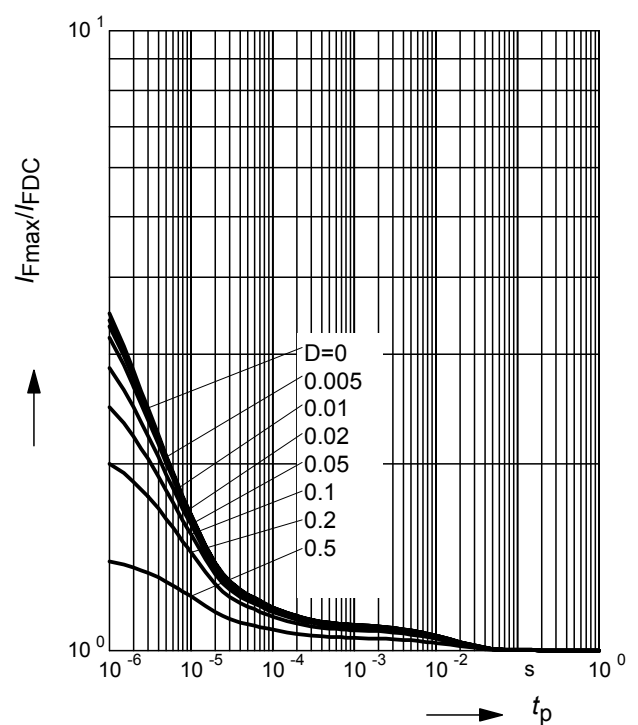
BAT62-03W



Permissible Pulse Load

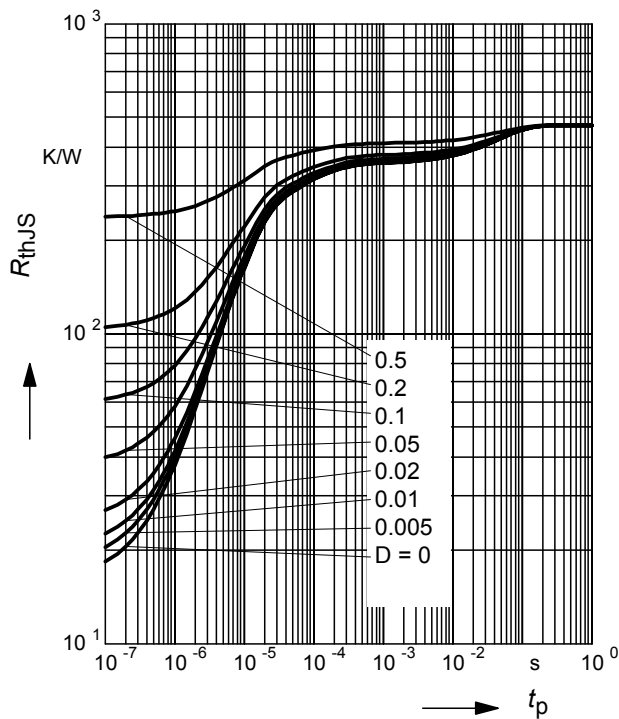
$$I_{Fmax}/I_{FDC} = f(t_p)$$

BAT62-03W



Permissible Puls Load $R_{thJS} = f(t_p)$

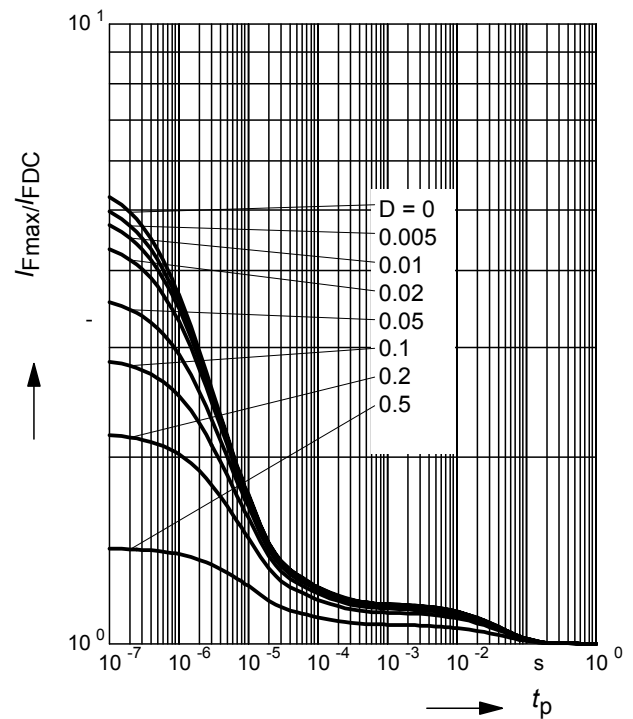
BAT62-07W



Permissible Pulse Load

$$I_{Fmax}/I_{FDC} = f(t_p)$$

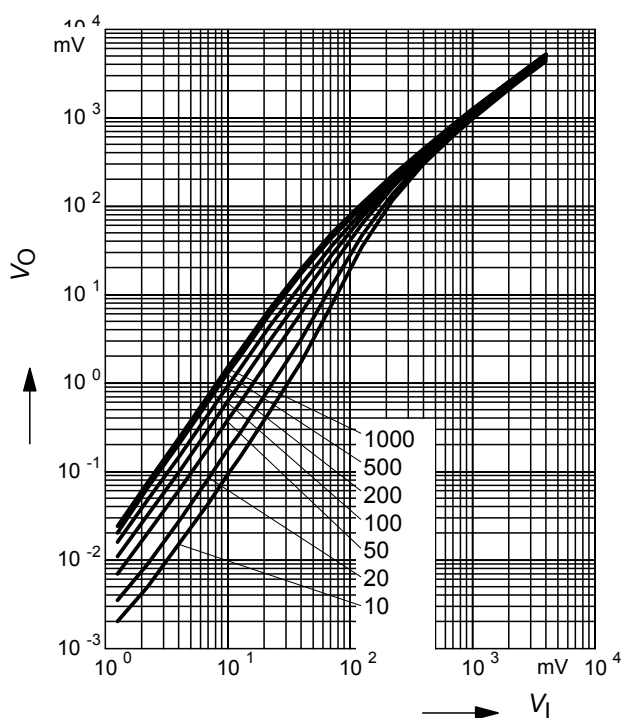
BAT62-07W



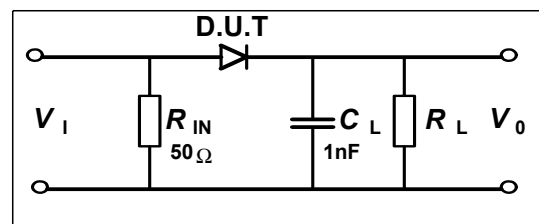
Rectifier voltage $V_{out} = f(V_{in})$

$f = 900\text{MHz}$

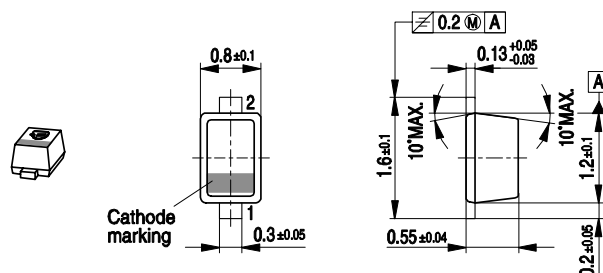
$R_L = \text{Parameter in k}\Omega$



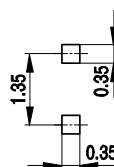
Testcircuit



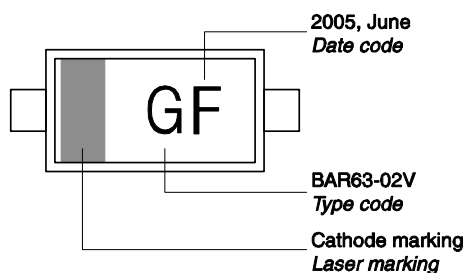
Package Outline



Foot Print

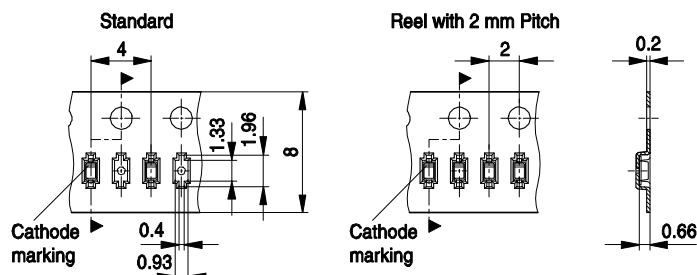


Marking Layout (Example)

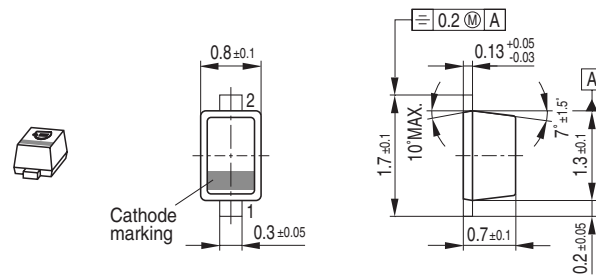


Standard Packing

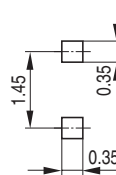
Reel $\varnothing 180$ mm = 3.000 Pieces/Reel
 Reel $\varnothing 180$ mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel $\varnothing 330$ mm = 10.000 Pieces/Reel



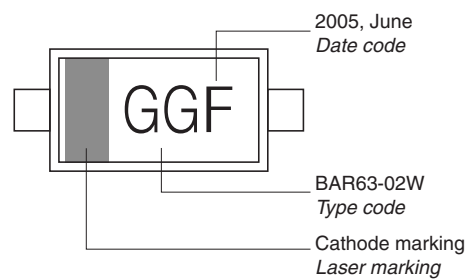
Package Outline



Foot Print

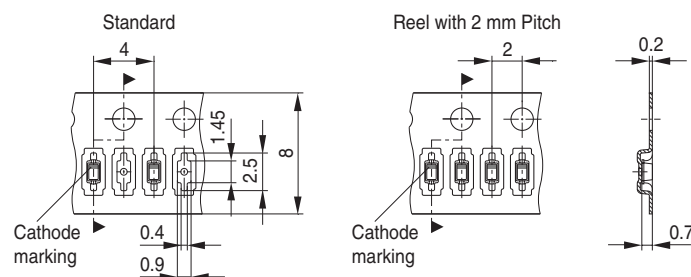


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
 Reel ø180 mm = 8.000 Pieces/Reel (2 mm Pitch)
 Reel ø330 mm = 10.000 Pieces/Reel

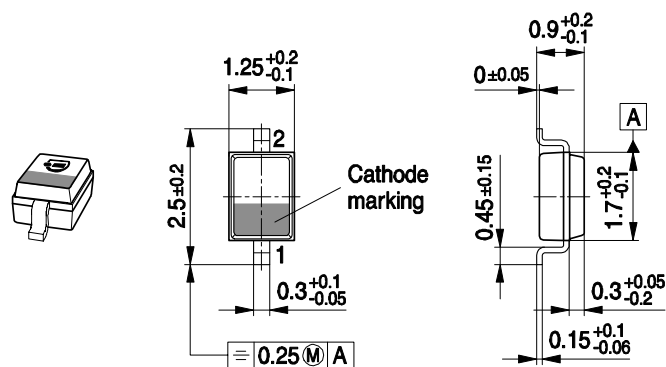


Date Code marking for discrete packages with one digit (SCD80, SC79, SC75¹⁾) CES-Code

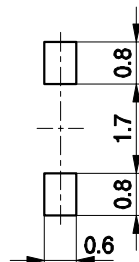
Month	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
01	a	p	A	P	a	p	A	P	a	p	A	P
02	b	q	B	Q	b	q	B	Q	b	q	B	Q
03	c	r	C	R	c	r	C	R	c	r	C	R
04	d	s	D	S	d	s	D	S	d	s	D	S
05	e	t	E	T	e	t	E	T	e	t	E	T
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	v	G	V	g	v	G	V	g	v	G	V
08	h	x	H	X	h	x	H	X	h	x	H	X
09	j	y	J	Y	j	y	J	Y	j	y	J	Y
10	k	z	K	Z	k	z	K	Z	k	z	K	Z
11	l	2	L	4	l	2	L	4	l	2	L	4
12	n	3	N	5	n	3	N	5	n	3	N	5

1) New Marking Layout for SC75, implemented at October 2005.

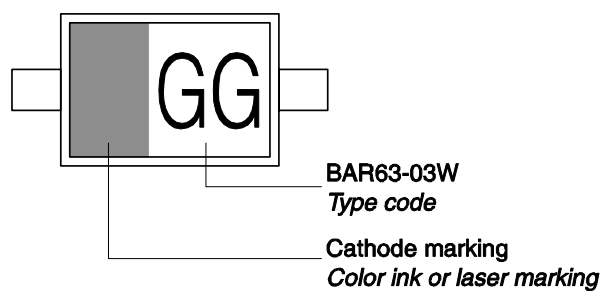
Package Outline



Foot Print

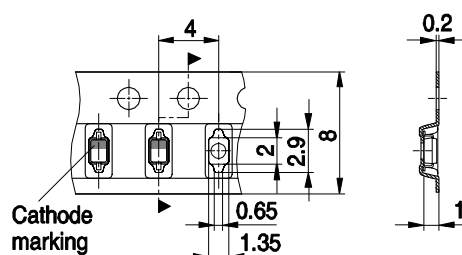


Marking Layout (Example)

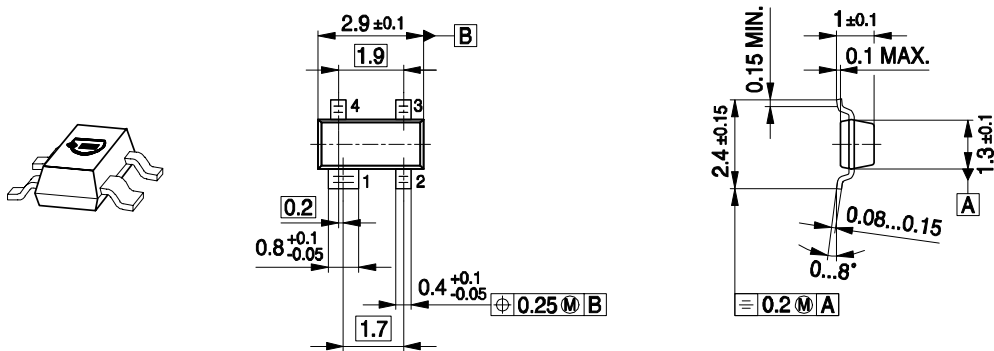


Standard Packing

Reel $\varnothing 180$ mm = 3.000 Pieces/Reel
 Reel $\varnothing 330$ mm = 10.000 Pieces/Reel



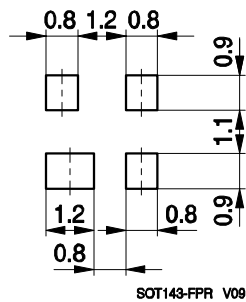
Package Outline



Note: Mold flash, protrusions or gate burrs of 0,2 mm max. per side are not included

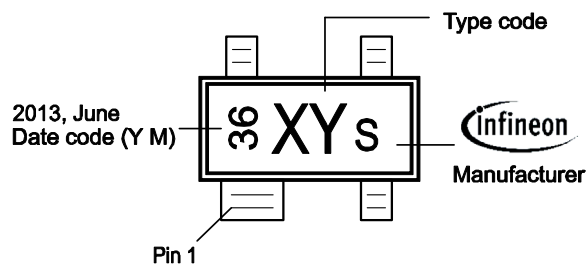
SOT143-PO V09

Foot Print



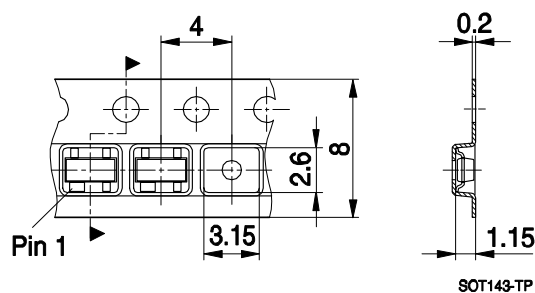
SOT143-FPR V09

Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel



SOT143-TP

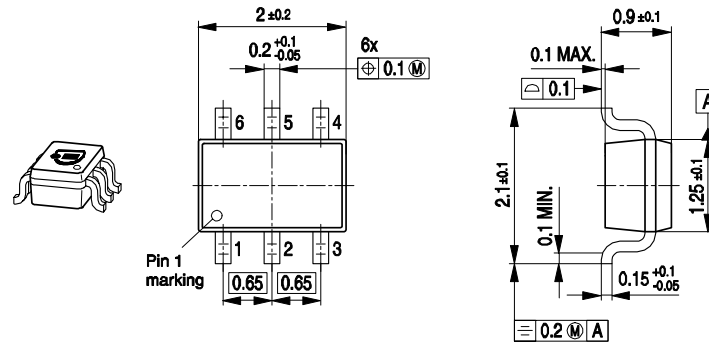
The technical drawing shows two views of the THT package:

- Top View:** A rectangular component with four leads labeled 1, 2, 3, and 4. Dimensions include a total width of 2 ± 0.2 , a lead pitch of 1.3 , a body width of 0.15 , and a lead thickness of $0.6^{+0.1}_{-0.05}$. There are also dimension callouts for $4x$ and $\oplus 0.1 \text{ M}$.
- Side View:** Shows the profile of the component with a maximum height of 0.9 ± 0.1 , a maximum lead height of 0.1 MAX. , a minimum standoff height of 0.1 MIN. , a total height of 2.1 ± 0.1 , and a base thickness of $0.15^{+0.1}_{-0.05}$. It also includes a dimension callout for $0.2 \text{ M} | A$.

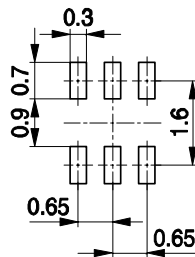
Diagram illustrating the marking on a 16-pin DIP package:

- Date code (YM):** 2005, June (indicated by '65')
- Type code:** XY
- Manufacturer:** s (Infineon logo is shown next to it)
- Pin 1:** Indicated by an arrow pointing to the bottom-left pin.

Package Outline

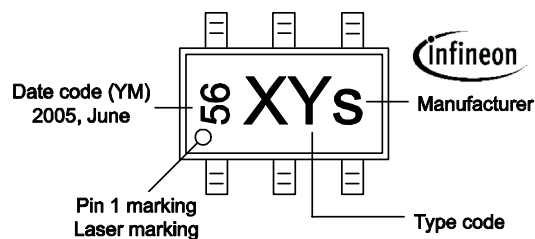


Foot Print



Marking Layout (Example)

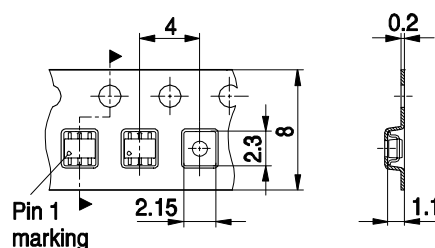
Small variations in positioning of
Date code, Type code and Manufacturer are possible.



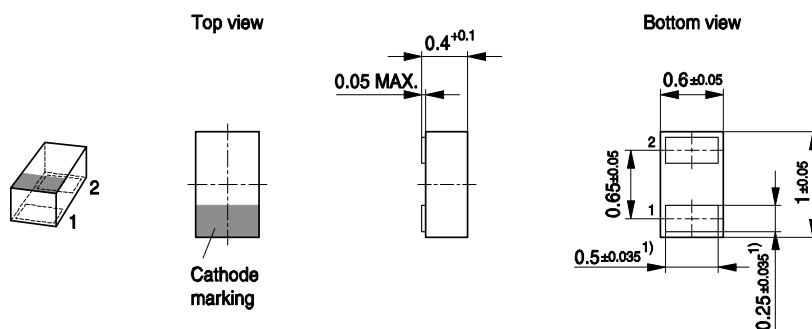
Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



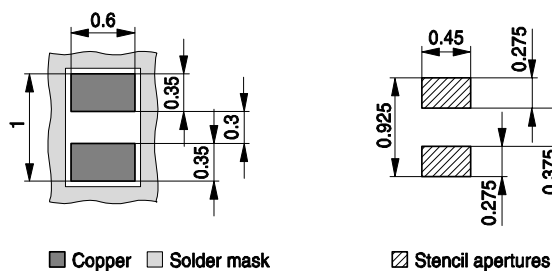
Package Outline



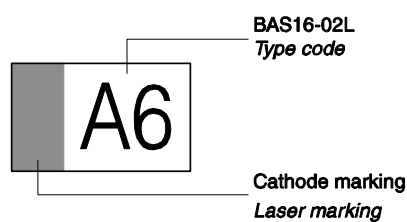
1) Dimension applies to plated terminal

Foot Print

For board assembly information please refer to Infineon website "Packages"



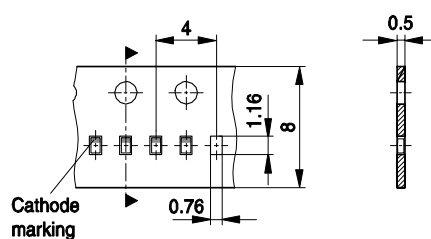
Marking Layout (Example)



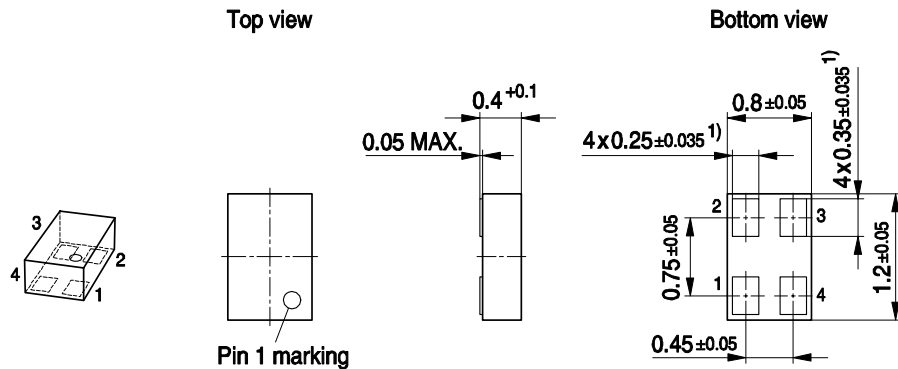
Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel

Reel ø330 mm = 50.000 Pieces/Reel (optional)



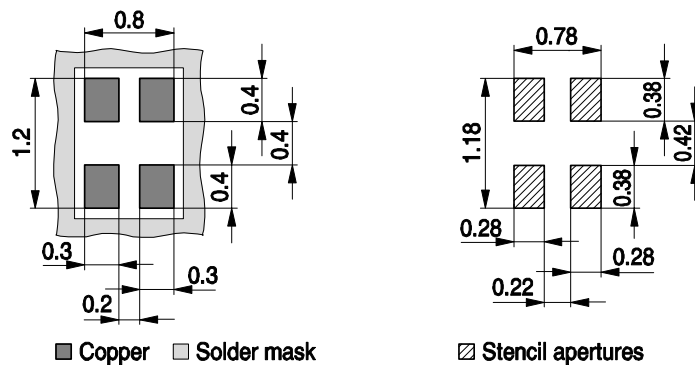
Package Outline



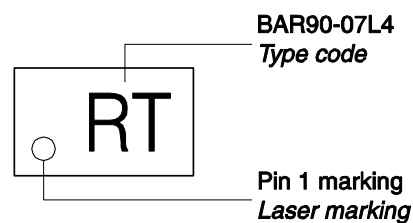
1) Dimension applies to plated terminal

Foot Print

For board assembly information please refer to Infineon website "Packages"

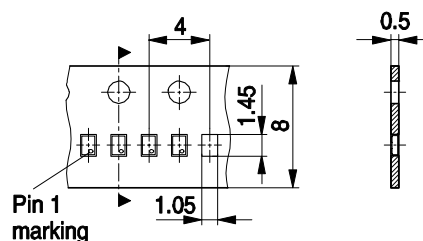


Marking Layout (Example)

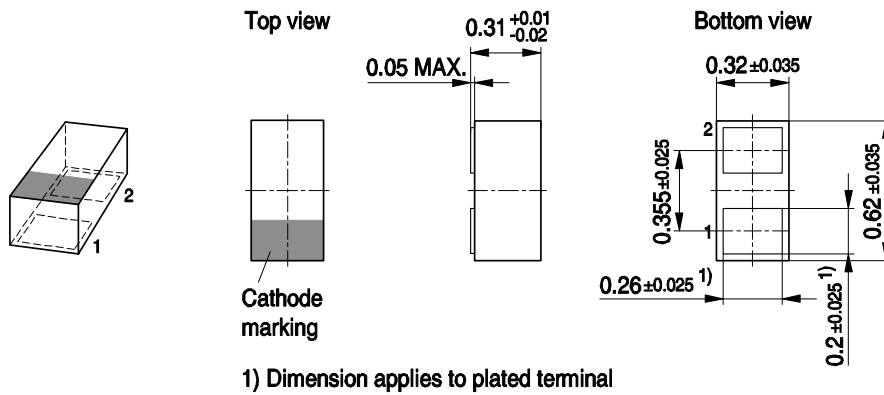


Standard Packing

Reel $\varnothing 180 \text{ mm}$ = 15.000 Pieces/Reel

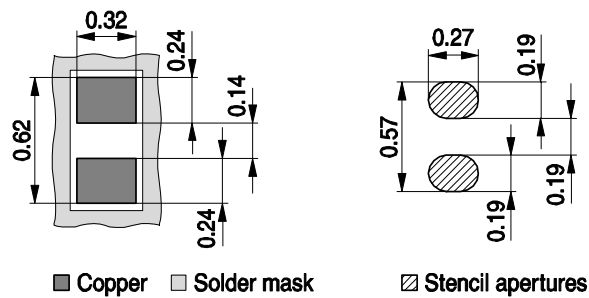


Package Outline

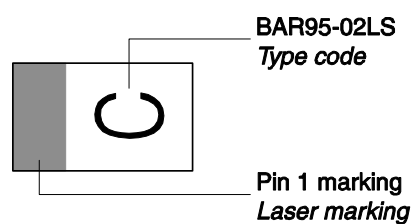


Foot Print

For board assembly information please refer to Infineon website "Packages"

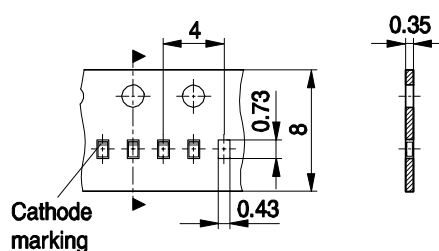


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel



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For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office ([<www.infineon.com>](http://www.infineon.com)).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.